



**PARA LIGHT ELECTRONICS CO., LTD.**

11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan,  
Tel: 886-2-2225-3733 Fax: 886-2-2225-4800  
E-mail: [para@para.com.tw](mailto:para@para.com.tw) <http://www.para.com.tw>

**DATA SHEET**

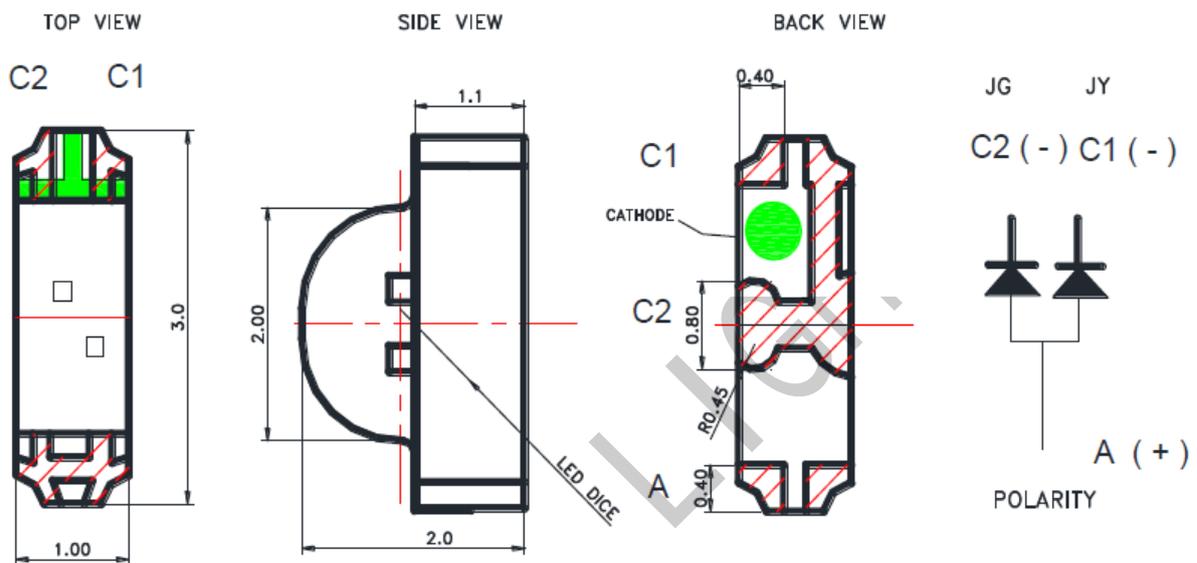
**PART NO.: LS116JYJGCT-ZX**

**REV: A / 1**

CUSTOMER'S APPROVAL : \_\_\_\_\_ DCC : \_\_\_\_\_

DRAWING NO. : DS-85-23-0004G DATE : 2023-12-09 Page 1

● PACKAGE OUTLINE DIMENSIONS



Notes:

1. All dimensions are in millimeters.
2. Tolerance is  $\pm 0.1\text{mm}$  (.004") unless otherwise noted.

● Features

- \* Side looking special for LCD backlight.
- \* Package in 8mm tape on 7" diameter reels.
- \* Compatible with automatic Pick & Place equipment.
- \* Compatible with InfraYellow and Wave soldering reflow solder processes.
- \* EIA STD package.
- \* I.C. compatible.
- \* Pb free product.
- \* Meet RoHS Green Product.
- \* Moisture sensitivity level: 3

● **Chip Materials**

chip	Light Color	Dice Material	Lens Color
C2	JG: Yellow Green	AlInGaP	Water Clear
C1	JY: Yellow		

● **Absolute Maximum Ratings(Ta=25°C)**

Symbol	Parameter	Rating		Unit
		JY	JG	
P <sub>D</sub>	Power Dissipation	60	60	mW
I <sub>PF</sub>	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	80	mA
I <sub>F</sub>	Continuous Forward Current	25	25	mA
V <sub>R</sub>	Reverse Voltage	5		V
T <sub>opr</sub>	Operating Temperature Range	-40 ~ +85		°C
T <sub>stg</sub>	Storage Temperature Range	-40 ~ +85		°C

● **Electro-Optical Characteristics(Ta=25°C, Condition B)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition	
Luminous Intensity	I <sub>V</sub>	JY	18	38	mcd	IF=20mA	
		JG	13	19			
Viewing Angle	2 θ 1/2		130		deg	Note 2	
Dominant Wavelength	λ <sub>d</sub>	JY		589	nm	IF=20mA	
		JG		573		IF=20mA	
Spectral Line Half-Width	Δ λ	JY		15	nm		
		JG		20			
Forward Voltage	V <sub>F</sub>	JY		2.0	2.4	V	IF =20mA
		JG		2.0	2.4	V	IF =20mA
Reverse Current	I <sub>R</sub>			10	μ A	VR = 5V	



# SURFACE MOUNT DEVICE LED

Part No. : LS116JYJGCT-ZX

REV:A / 1

## Bin Code List

Luminous Intensity(IV), Unit:mcd@20mA			
JY		JG	
Bin Code	Min- Max	Bin Code	Min- Max
M	18.0-28.0	L	13.0-18.0
N	28.0-45.0	M	18.0-28.0
P	45.0-71.0	N	28.0-45.0

Tolerance of each bin are  $\pm 15\%$

Dominant Wavelength (Hue), JG		
Unit: nm@20mA		
Bin	Min	Max
C	567.5	570.5
D	570.5	573.5
E	573.5	576.5

Tolerance of each bin are  $\pm 1\text{nm}$

### Notes:

1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength  $\lambda_d$  is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
4. Caution in ESD :  
Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
5. Major standard testing equipment by "Instrument System" Model: CAS140D Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

● **Yellow Typical Electro-Optical Characteristics Curves**

(25°C Ambient Temperature Unless Otherwise Noted)

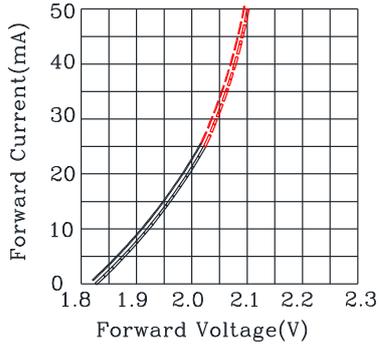


Fig.2 Forward Current vs.Forward Voltage

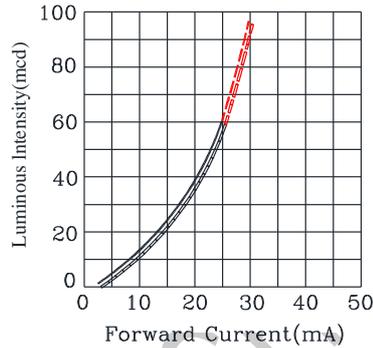


Fig.3 Luminous Intensity vs.Forward Current

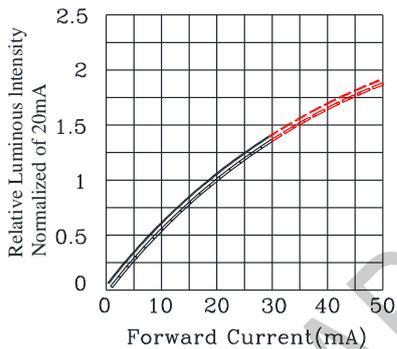


Fig.4 Relative Luminous Intensity vs.Forward Current

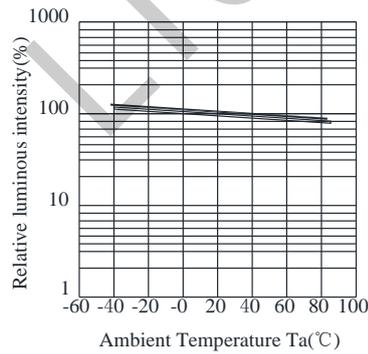


Fig.5 Luminous Intensity vs.Ambient Temperature

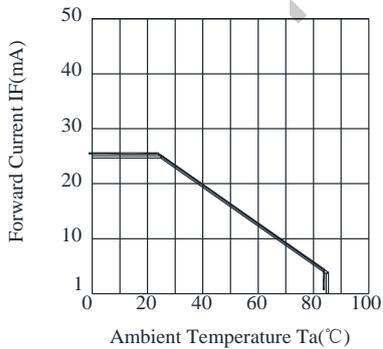


Fig.6 Forward Current Derating Curve

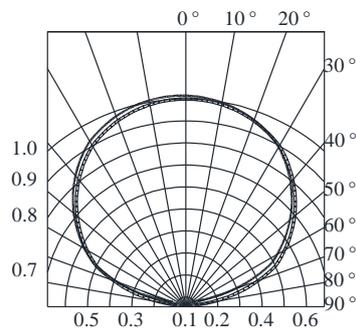


Fig.7 Relative Intensity vs.Angle

● **Yellow Green Typical Electro-Optical Characteristics Curves**

(25°C Ambient Temperature Unless Otherwise Noted)

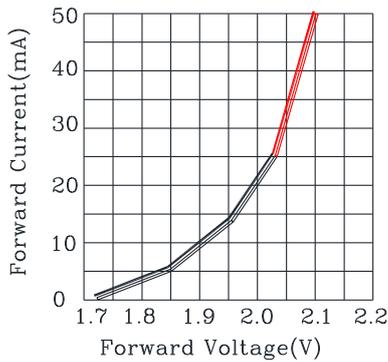


Fig.2 Forward Current vs.Forward Voltage

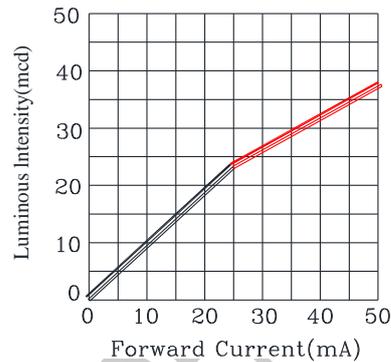


Fig.3 Luminous Intensity vs.Forward Current

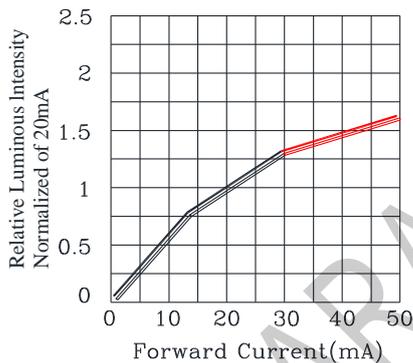


Fig.4 Relative Luminous Intensity vs.Forward Current

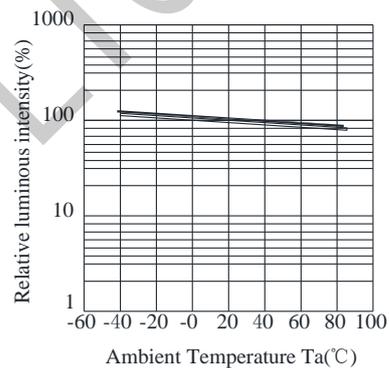


Fig.5 Luminous Intensity vs.Ambient Temperature

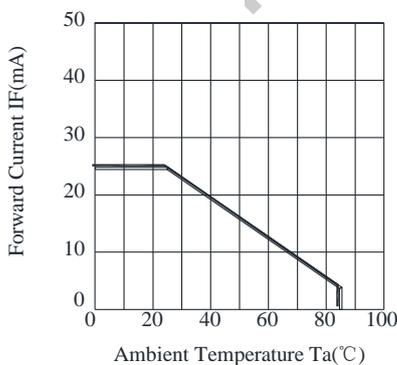


Fig.6 Forward Current Derating Curve

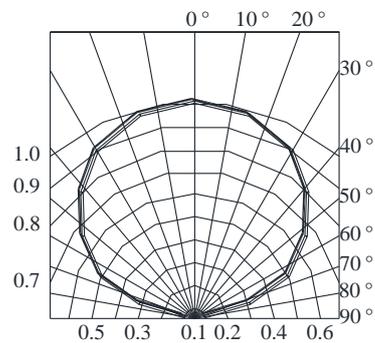


Fig.7 Relative Intensity vs.Angle

● Label Explanation



ITEM CODE:PARRA LIGHT

PART NO: LS116JYJGCT-ZX

IV --- Luminous Intensity Code

LOT NO: EM S L 12 09 0110  
          A    B    C    D    E    F

A---EM: Emos Code

B---S:SMD

L---Local

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG :

3000pcs for 150、170、110、155、115 、116series

4000pcs for 191 series

5000pcs for 192 series

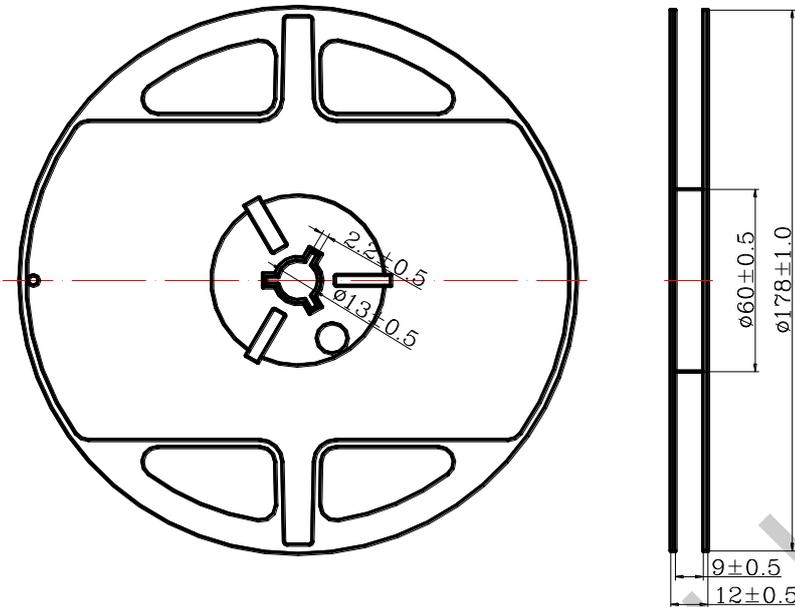
DATE CODE: 2012 09 10  
                  G    H    I

G--- Year

H--- Month

I --- Day

Reel Dimensions



Notes:

1. Taping Quantity : 3000pcs
2. The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5^\circ$  , Unit : mm.

Typical Electro-Optical Characteristics Curves

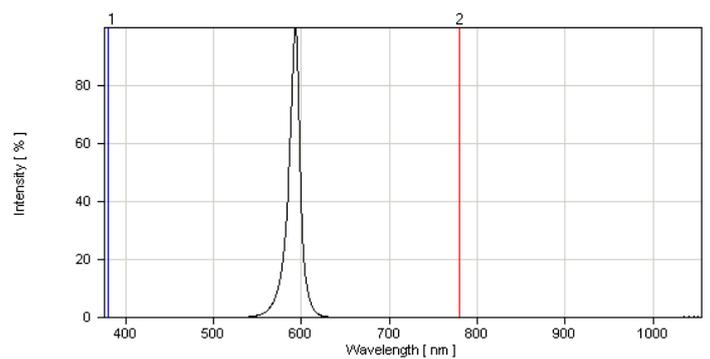
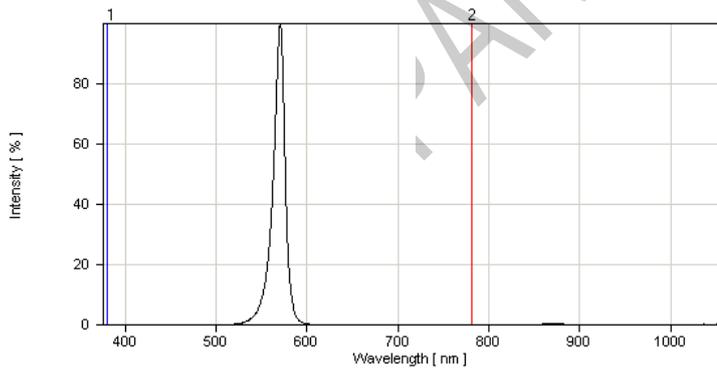
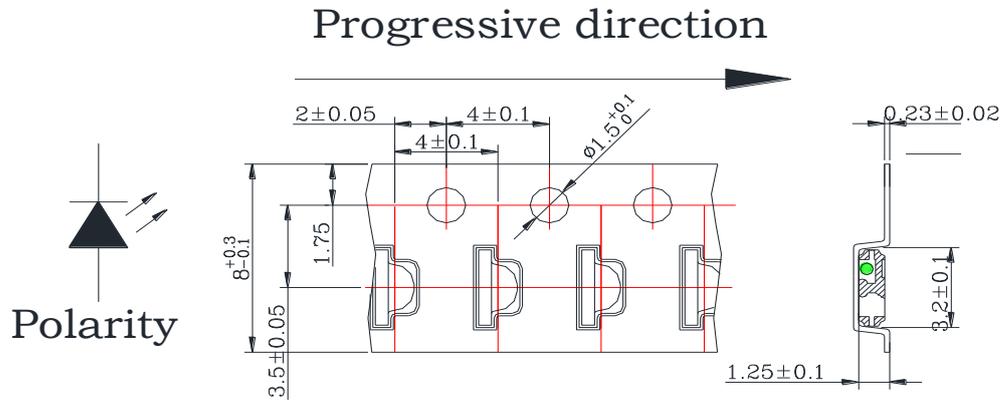


Fig.1 Super Green Relative Intensity vs. Wavelength

Fig.2 Super Yellow Relative Intensity vs. Wavelength

● Package Dimensions Of Tape And Reel

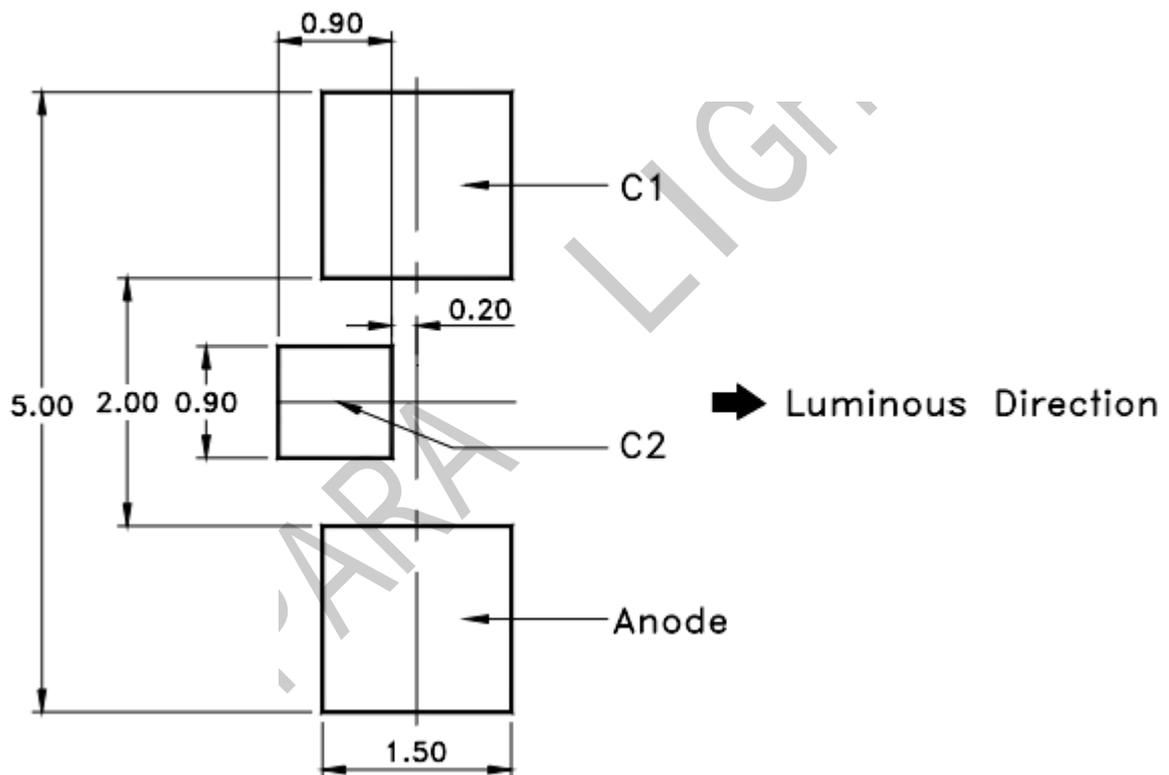


Notes: All dimensions are in millimeters.

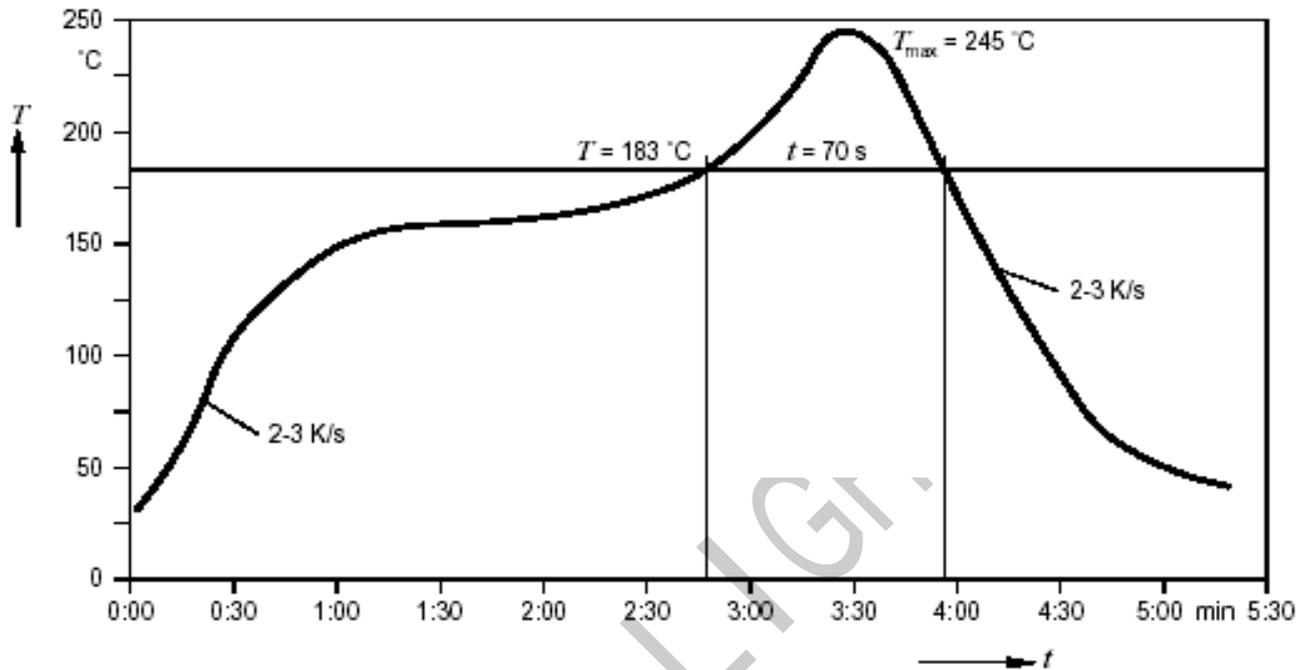
● **Cleaning**

- \* If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- \* Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- \* Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

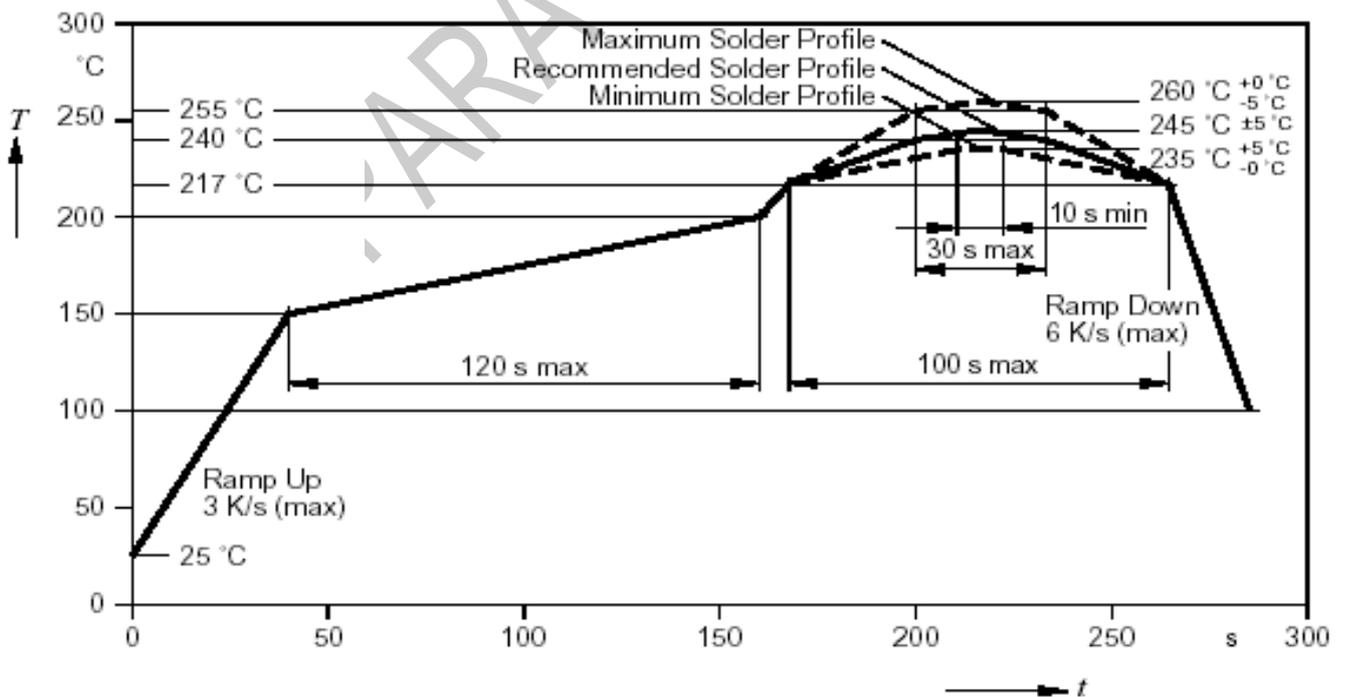
● **Suggest Soldering Pad Dimensions**



● Suggest Sn/Pb IR Reflow Soldering Profile Condition:



● Suggest Pb-Free IR Reflow Soldering Profile Condition:



## ● CAUTIONS

### 1. Application Limitation :

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

### 2. Storage :

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours

### 3. Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering :

Pre-heat 120~150 °C, 120sec. MAX., Peak temperature : 240 °C Max. Soldering time : 10 sec Max.

Soldering Iron : (Not recommended)

Temperature 300 °C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering :

Pre-heat 100 °C Max, Pre-heat time 60 sec. Max, Solder wave 260 °C Max, Soldering time 5 sec. Max. performed consecutively cooling process is required between 1<sup>st</sup> and 2<sup>nd</sup> soldering processes.

4. Lead-Free Soldering

For Reflow Soldering :

- 1、 Pre-Heat Temp:150-180°C,120sec.Max.
- 2、 Soldering Temp:Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3、 Peak Temperature:260°C , 5sec.
- 4、 Reflow Repetition:2 Times Max.
- 5、 Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu

For Soldering Iron (Not Recommended) :

- 1、 Iron Tip Temp:350°C Max.
- 2、 Soldering Iron:30w Max.
- 3、 Soldering Time:3 Sec. Max. One Time.

For Dip Soldering :

- 1、 Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2、 Bath Temp:265°C Max.
- 3、 Dip Time:5 Sec. Max.

5. Drive Method



(A)Recommended circuit.

(B)The difference of brightness between LED`s could be found due to the Vf-If characteristics of LED.